

## **MOSFET**

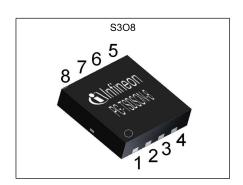
### OptiMOS<sup>™</sup>3 Power-Transistor, 100 V

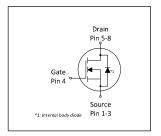
#### **Features**

- Ideal for high frequency switching
  Optimized technology for DC/DC converters
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  N-channel, Logic level
  100% avalanche tested
  Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21



Table 1 Rey 1 circimanoc 1 arameters							
Parameter	Value	Unit					
V <sub>DS</sub>	100	V					
R <sub>DS(on),max</sub>	15	m $Ω$					
ID	47	A					











Type / Ordering Code	Package	Marking	Related Links
BSZ150N10LS3 G	PG-TSDSON-8	150N10L	-



### **Table of Contents**

Description	
Maximum ratings 3	ŀ
Thermal characteristics	,
Electrical characteristics	
Electrical characteristics diagrams6	ı
Package Outlines	i
Revision History	
Frademarks11	
Disclaimer	



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	C b l		Values			N	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	47 30 8	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W $^{2)}$	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	188	Α	T <sub>C</sub> =25 °C	
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	80	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	63 2.1	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 K/W <sup>2)</sup>	
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

#### 2 Thermal characteristics

Table 3 **Thermal characteristics** 

Davamatav	Cumbal	Values			11:4	Nata / Tast Canditian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	$R_{thJC}$	-	-	2	K/W	-	
Device on PCB, minimal footprint	$R_{thJA}$	-	-	62	K/W	-	
Device on PCB, 6 cm <sup>2</sup> cooling area <sup>2)</sup>	$R_{thJA}$	_	_	60	K/W	-	

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See figure 3 for more detailed information

4) See figure 13 for more detailed information



#### **Electrical characteristics**

at T<sub>j</sub>=25 °C, unless otherwise specified

Static characteristics Table 4

Danamatan	C		Values				
Parameter	Symbol	Min.	Тур. Мах.		Unit	Note / Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	100	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	1.1	1.7	2.1	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=33\ \mu {\rm A}$	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>i</sub> =25 °C V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>i</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	16 13	20 15	mΩ	V <sub>GS</sub> =4.5 V, I <sub>D</sub> =20 A V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A	
Gate resistance	R <sub>G</sub>	-	1.2	-	Ω	-	
Transconductance	$g_{fs}$	21	42	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 20 A$	

Table 5 **Dynamic characteristics** 

Danier de la constante de la c	Consolo al		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	1900	2500	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz	
Output capacitance <sup>1)</sup>	Coss	-	280	370	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz	
Reverse transfer capacitance	C <sub>rss</sub>	-	12	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	8.1	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Rise time	t <sub>r</sub>	-	4.6	-	ns	$V_{\rm DD} = 50 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 10 \text{ A}, R_{\rm G,ext} = 1.6 \Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	23.4	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Fall time	t <sub>f</sub>	-	3.9	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 $\Omega$	

Gate charge characteristics<sup>2)</sup> Table 6

Davamatar	Comple al	Values			11	Note / Took Coundition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	$Q_{gs}$	-	5.2	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	2.7	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge	$Q_{ m gd}$	-	4.1	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	7.7	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	$Q_g$	-	26	35	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	2.7	-	V	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Output charge <sup>1)</sup>	Qoss	_	28	37	nC	V <sub>DD</sub> =50 V, V <sub>GS</sub> =0 V

Defined by design. Not subjected to production test See "Gate charge waveforms" for parameter definition.

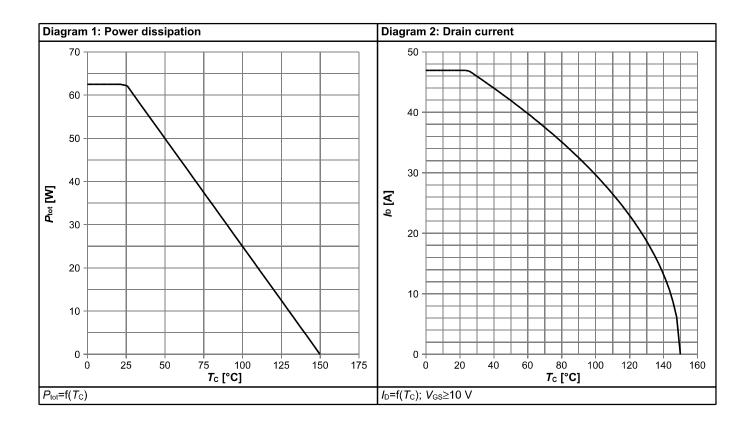


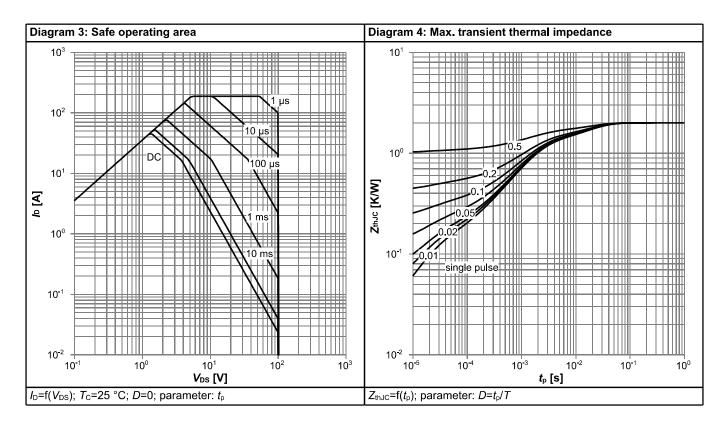
### Table 7 Reverse diode

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Symbol	Min.	Тур.	Max.	Offic	Note / Test Condition	
Diode continuous forward current	Is	-	-	45	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	188	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.87	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C	
Reverse recovery time	t <sub>rr</sub>	-	53	-	ns	V <sub>R</sub> =50 V, I <sub>F</sub> =10A, di <sub>F</sub> /dt=100 A/μs	
Reverse recovery charge	Q <sub>rr</sub>	-	84	-	nC	V <sub>R</sub> =50 V, I <sub>F</sub> =10A, di <sub>F</sub> /dt=100 A/μs	

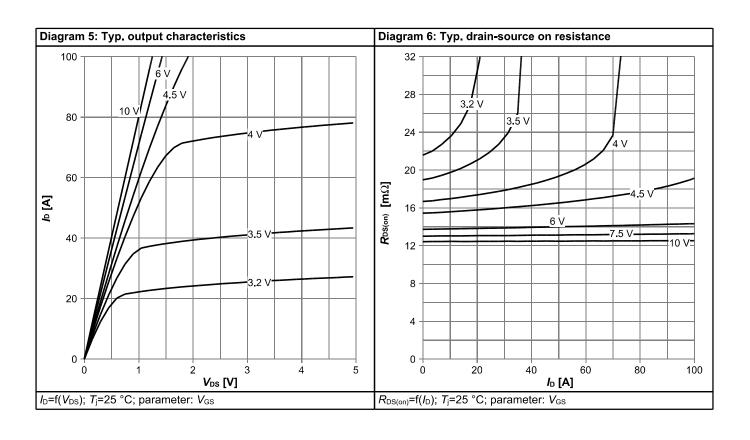


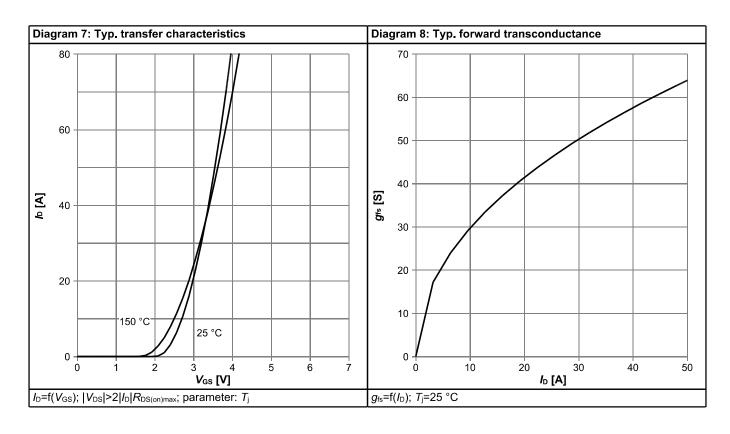
#### 4 Electrical characteristics diagrams



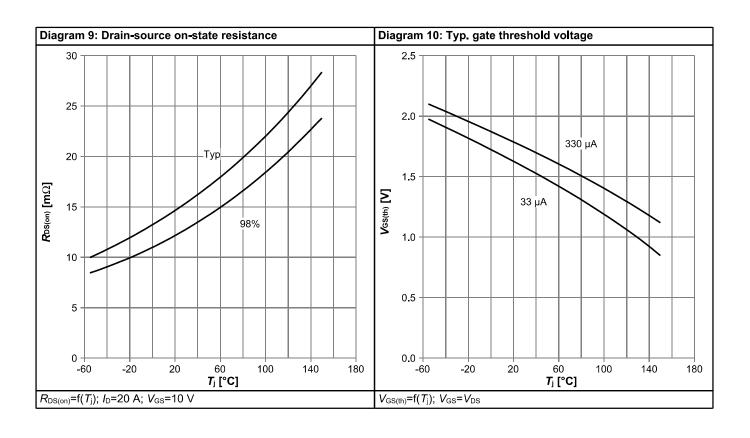


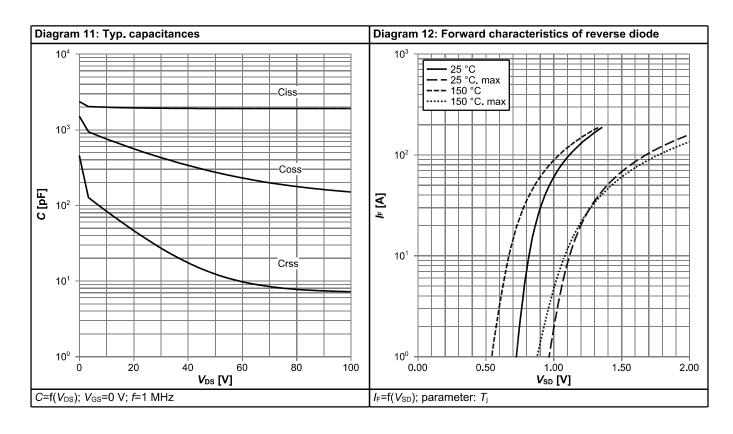




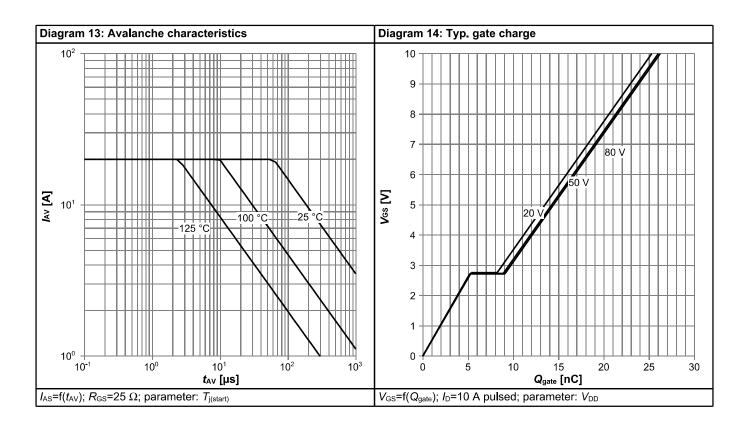


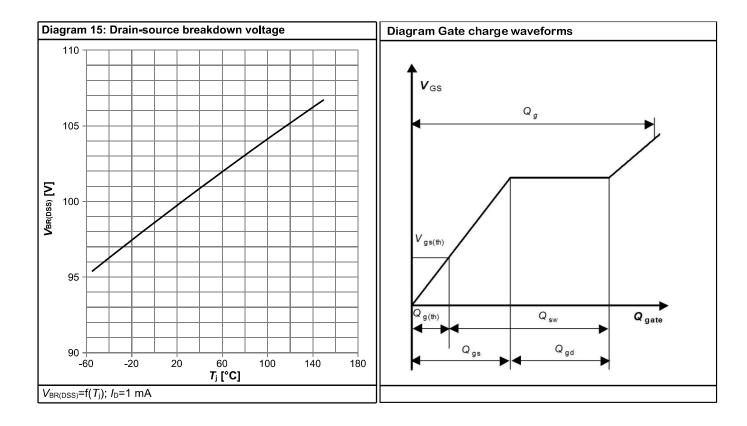






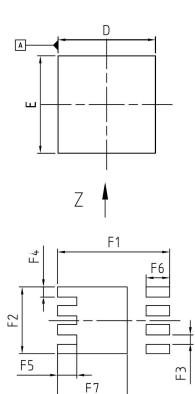


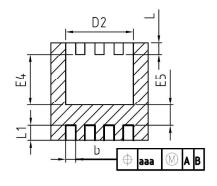


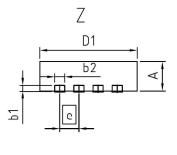




## 5 Package Outlines







DIM	MILLIME	INCH	IES		
ЫМ	MIN	MAX	MIN	MAX	
Α	0.90	1.10	0.035	0.043	
b	0.24	0.44	0.009	0.017	
b1	0.10	0.30	0.004	0.012	
b2	0.20	0.44	0.008	0.017	
D=D1	3.20	3.40	0.126	0.134	
D2	2.15	2.45	0.085	0.096	
E	3.20	3.40	0.126	0.134	
E4	1.60	1.81	0.063	0.071	
E5	0.59	0.86	0.023	0.034	
е	0.6	5	0.026		
N	8		8	3	
L	0.30	0.56	0.012	0.022	
L1	0.33	0.60	0.013	0.024	
aaa	0.25	5	0.010		
F1	3.80	כ	0.1	50	
F2	2.29	9	0.0	190	
F3	0.3	1	0.012		
F4	0.34	4	0.013		
F5	0.69	5	0.026		
F6	0.80	)	0.0	131	
F7	2.36	6	0.0	93	

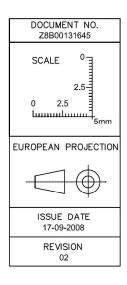


Figure 1 Outline PG-TSDSON-8, dimensions in mm/inches



#### **Revision History**

BSZ150N10LS3 G

Revision: 2022-01-26, Rev. 2.4

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.3	2021-03-16	Update Id Max current rating				
2.4	2022-01-26	Update switching symbol and footnotes				

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